REVISIONS			
LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED
A	Add device type 02. Technical changes to table I. Editorial changes throughout.	93-01-07	Michael A Frye

查询"5962-87750EX"供应商

REV																			
SHEET																			
REV																			
SHEET																			

REV STATUS OF SHEETS															
REV	A	A	A	A	A	A	A	A							
SHEET	1	2	3	4	5	6	7	8							

PMIC N/A

STANDARDIZED MILITARY DRAWING

THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE

AMSC N/A

PREPARED BY
Marcia B Kelleher

CHECKED BY
Charles E Besore

APPROVED BY
Michael A Frye

DRAWING APPROVAL DATE
87-12-30

REVISION LEVEL
A

DEFENSE ELECTRONICS SUPPLY CENTER
DAYTON, OHIO 45444

MICROCIRCUIT, LINEAR, 5-VOLT POSITIVE REGULATOR, MONOLITHIC SILICON

SIZE	CAGE CODE	
A	67268	5962-87775

SHEET 1 OF 8

1

DESC FORM 193
JUL 91

5962-E079-93

DISTRIBUTION STATEMENT A. Approved for public release; distribution is unlimited.

Powered by ICminer.com Electronic-Library Service CopyRight 2003

1. SCOPE

查询"5962-87750HX"供应商

1.1 Scope. This drawing describes device requirements for class B microcircuits in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices".

1.2 Part or Identifying Number (PIN). The complete PIN shall be as shown in the following example:

5962-87775	01	Y	X
Drawing number	Device type (see 1.2.1)	Case outline (see 1.2.2)	Lead finish (see 1.2.3)

1.2.1 Device type(s). The device type(s) shall identify the circuit function as follows:

Device type	Generic number	Circuit function
01	LM123K	5-volt positive regulator
02	LT123AK	5-volt positive regulator

1.2.2 Case outline(s). The case outline(s) shall be as designated in MIL-STD-1835 and as follows:

Outline letter	Descriptive designator	Terminals	Package style
Y	See figure 1	2	TO-3

1.2.3 Lead finish. The lead finish shall be as specified in MIL-M-38510. Finish letter "X" shall not be marked on the microcircuit or its packaging. The "X" designation is for use in specifications when lead finishes A, B, and C are considered acceptable and interchangeable without preference.

1.3 Absolute maximum ratings.

Input voltage (V_{IN})	20 V dc
Storage temperature range	-65°C to +150°C
Maximum power dissipation (P_D)	Internally limited
Lead temperature (soldering, 10 seconds)	+300°C
Thermal resistance, junction-to-case (Θ_{JC})	3°C/W 1/
Maximum output current (I_{MAX})	3.0 A

1.4 Recommended operating conditions.

Ambient operating temperature range (T_A)	-55°C to +125°C

2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and bulletin. Unless otherwise specified, the following specification, standards, and bulletin of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510 - Microcircuits, General Specification for.

1/ Without a heat sink, the thermal resistance of the TO-3 package is about 35°C/W. With a heat sink, the effective thermal resistance can only approach the value of 2°C/W, depending on the efficiency of the heat sink.

Powered by ICminer.com Electronic-Library Service CopyRight 2003

STANDARDS

查询"5962-8777501YX"供应商

MILITARY

MIL-STD-883 - Test Methods and Procedures for Microelectronics.
MIL-STD-1835 - Microcircuit Case Outlines.

BULLETIN

MILITARY

MIL-BUL-103 - List of Standardized Military Drawings (SMD's).

(Copies of the specification, standards, and bulletin required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.

3.2.1 Case outline(s). The case outline(s) shall be in accordance with 1.2.2 herein and figure 1.

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 2.

3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full ambient operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

3.5 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked as listed in MIL-BUL-103 (see 6.6 herein).

3.6 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-BUL-103 (see 6.6 herein). The certificate of compliance submitted to DESC-EC prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.

3.7 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.

3.8 Notification of change. Notification of change to DESC-EC shall be required in accordance with MIL-STD-883 (see 3.1 herein).

3.9 Verification and review. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).

Powered by ICminer.com Electronic-Library Service CopyRight 2003

TABLE I. Electrical performance characteristics.

查询"5962-8777501YX"供应商

Test	Symbol	Conditions $-55°C \le T_A \le +125°C$ unless otherwise specified	Device type	Group A subgroups	Limits		Unit
					Min	Max	
Output voltage	V_{OUT}	V_{IN} = 7.5 V, T_A = +25°C, I_{OUT} = 0 mA	01	1	4.7	5.3	V
			02		4.95	5.05	
		7.5 V ≤ V_{IN} ≤ 15 V, 0 A ≤ I_{OUT} ≤ 3 A, P ≤ 30 W	01	1, 2, 3	4.6	5.4	V
			02		4.85	5.15	
Line regulation 1/	V_{RLINE}	7.5 V ≤ V_{IN} ≤ 15 V, I_{OUT} = 0 A	01	1	-25	+25	mV
			02		-10	+10	
Load regulation 1/	V_{RLOAD}	V_{IN} = 7.5 V, 0 A ≤ I_{OUT} ≤ 3 A	01	1	-100	+100	
			02		-50	+50	
Quiescent current	I_Q	V_{IN} = 15 V, 0 A ≤ I_{OUT} ≤ 3 A	All	1,2,3		20	mA
		V_{IN} = 7.5 V, 0 A ≤ I_{OUT} ≤ 3 A	All	1,2,3		20	
Short circuit current	ISC	V_{IN} = 15 V, T_A = +25°C	All	1		4.5	A
		V_{IN} = 7.5 V, T_A = +25°C	01	1		5	
			02			6	
Long term stability of output voltage	S	2/	All	1,2,3		35	mV
Ripple rejection	RR	8.0 V ≤ V_{IN} ≤ 18 V, T_A = +25°C, I_{OUT} = 2.0 A, f = 120 Hz	All	4	56		dB

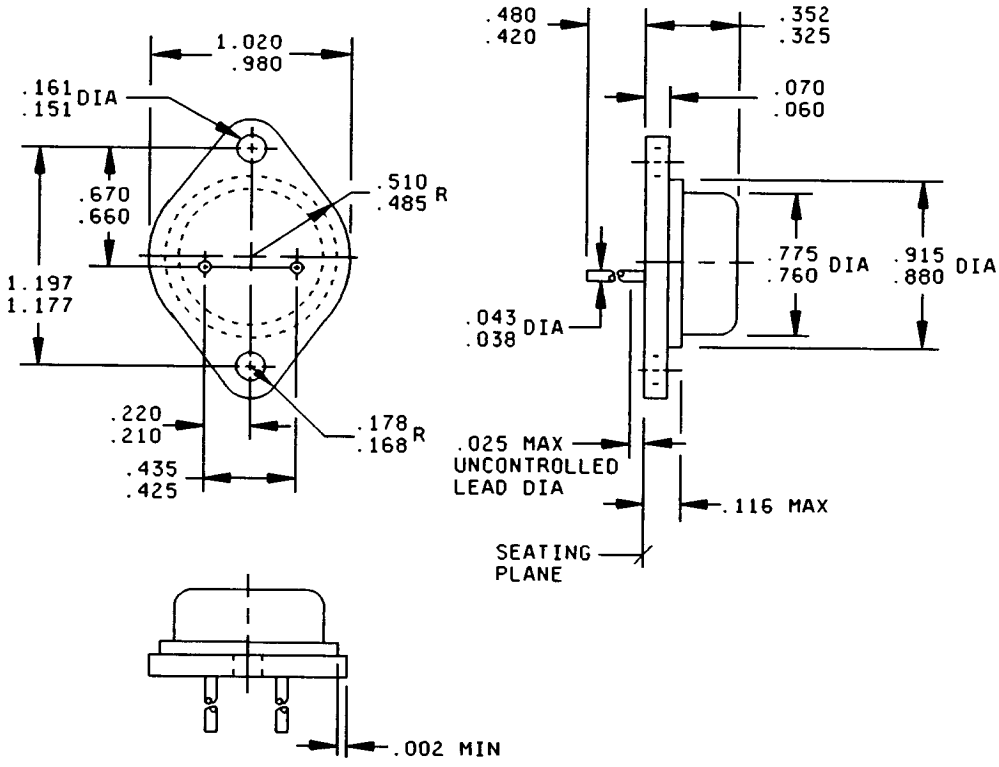
1/ Load and line regulation are tested with pulsed low duty cycle techniques where pulse width ≤ 1 ms and duty cycle ≤ 5 percent.
2/ Guaranteed, if not tested, to the limits specified.

Powered by ICminer.com Electronic-Library Service CopyRight 2003

Case outline Y

查询"5962-8777501YX"供应商

Device types 01 and 02



Inches	mm	Inches	mm	Inches	mm
.002	0.05	.178	4.52	.510	12.95
.025	0.64	.210	5.33	.660	16.76
.038	0.97	.220	5.59	.670	17.02
.043	1.09	.325	8.26	.760	19.30
.060	1.52	.352	8.94	.775	19.69
.070	1.78	.420	10.67	.880	22.35
.116	2.95	.425	10.80	.915	23.24
.151	3.84	.435	11.05	.920	23.37
.161	4.09	.480	12.19	1.020	25.91
.168	4.27	.485	12.39	1.177	29.90
				1.197	30.40

NOTES:
1. Dimensions are in inches.
2. Metric equivalents are given for general information only.

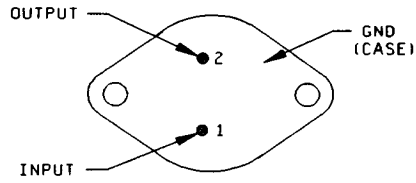
FIGURE 1. Case outline.

Powered by ICminer.com Electronic-Library Service CopyRight 2003

Case outline Y

Device types 01 and 02

查询"5962-8777501YX"供应商



BOTTOM VIEW

FIGURE 2. Terminal connections.

Powered by ICminer.com Electronic-Library Service CopyRight 2003

查询"5962-8777501YX"供应商

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (in accordance with method 5005, table I)
Interim electrical parameters (method 5004)	---
Final electrical test parameters (method 5004)	1*, 2, 3
Group A test requirements (method 5005)	1, 2, 3, 4
Groups C and D end-point electrical parameters (method 5005)	1, 2, 3

* PDA applies to subgroup 1.

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.

(2) T_A = +125°C, minimum.

b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

4.3.1 Group A inspection.

a. Tests shall be as specified in table II herein.

b. Subgroups 5, 6, 7, 8, 9, 10, and 11 in table I, method 5005 of MIL-STD-883 shall be omitted.

4.3.2 Groups C and D inspections.

a. End-point electrical parameters shall be as specified in table II herein.

b. Steady-state life test conditions, method 1005 of MIL-STD-883.

(1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.

Powered by ICminer.com Electronic-Library Service CopyRight 2003

(2) T_A = +125°C, minimum.

(3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

查询"5962-8777501YX"供应商

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for original equipment manufacturer application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-481 using DD Form 1693, Engineering Change Proposal (Short Form).

6.4 Record of users. Military and industrial users shall inform Defense Electronics Supply Center when a system application requires configuration control and the applicable SMD. DESC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DESC-EC, telephone (513) 296-6047.

6.5 Comments. Comments on this drawing should be directed to DESC-EC, Dayton, Ohio 45444, or telephone (513) 296-5377.

6.6 Approved sources of supply. Approved sources of supply are listed in MIL-BUL-103. The vendors listed in MIL-BUL-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DESC-EC.

Powered by ICminer.com Electronic-Library Service CopyRight 2003